

A/D 581-40

10-30-2002

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U.S. DEPARTMENT OF COMMERCE
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Please record the attached origin

102265415

5728402 10/30/2002

1. Name of conveying party(ies):

Keizo MASAWAKI

8-8-02

2. Name and address of receiving party(ies):

Name: Japan U-PICA Company, Ltd.

Internal Address:

Additional name(s) of conveying party(ies)
attached? ☐ Yes ☒ No

3. Nature of Conveyance

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: July 15, 2002

Street Address: 1-1, Uchisaiwaicho 2-chome
Chiyoda-ku

City: Tokyo State: Japan ZIP: 100-0011

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

10203418

If this document is being filed together with a new application, the execution date
of the application is: July 15, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom
correspondence concerning document
should be mailed:

Name: SHERMAN & SHALLOWAY

Internal Address: _____

6. Total number of applications and patents
involved: [1]

7. Total fee (37 CFR 3.41).....\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any
attached copy is a true copy of the original document

Leonard W. Sherman

Name of Person Signing

Signature

August 6, 2002

Date

Total number of pages including cover sheet, attachments, and document [2]

ASSIGNMENT

WHEREAS, I, Keizo Masawaki, residing respectively at c/o Research Institute of Japan U-PICA Company, Ltd., 3-3, Higashiyawata 5-chome, Hiratsuka-shi, Kangawawa 254-0016, JAPAN (hereinafter referred to as Inventors), have invented certain new and useful improvements in O/W AQUEOUS THERMOSETTING RESIN DISPERSION, FRP PRECISION FILTER MEDIUM MADE WITH THE AQUEOUS DISPERSION, AND PROCESS FOR PRODUCING THE SAME; for which an application for United States Letters Patent was filed in the United States on N/A and assigned Serial Number N/A.

WHEREAS, Japan U-PICA Company, Ltd., a corporation of Japan, having a place of business at 1-1, Uchisaiwaicho 2-chome, Chiyoda-ku, Tokyo 100-0011, JAPAN (hereinafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents do sell, assign and transfer unto said Company, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company as the assignee of the entire right, title and interest in and to the same, for the sole use and behalf of the said Company, its successors and assigns.

FURTHER, We agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Company, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, We have hereunto set our hands this 15th day of July, 2002.

Signed in the presence of:

Witness: Shiro Nakamura
Shiro Nakamura

Signed: Keizo Masawaki
Keizo Masawaki

Witness: _____

Signed: _____

Witness: _____

Signed: _____

Witness: _____

Signed: _____